EGP20A, EGP20B, EGP20C, EGP20D, EGP20F, EGP20G



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Vishay General Semiconductor

Glass Passivated Ultrafast Plastic Rectifier



| SUPERECTIFIER® |
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| |
| DO-204AC (DO-15) |

| SUPERECTIFIER® |
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| |
| DO-204AC (DO-15) |

| PRIMARY CHARACTERISTICS | | | | | | | |
|-------------------------|---|--|--|--|--|--|--|
| I _{F(AV)} | 2.0 A | | | | | | |
| V _{RRM} | 50 V, 100 V, 150 V, 200 V, 300 V, 400 V | | | | | | |
| I _{FSM} | 75 A | | | | | | |
| t _{rr} | 50 ns | | | | | | |
| V _F | 0.95 V, 1.25 V | | | | | | |
| T _J max. | 150 °C | | | | | | |
| Package | DO-204AC (DO-15) | | | | | | |
| Diode variations | Single die | | | | | | |

FEATURES

- Superectifier structure for high reliability condition
- · Cavity-free glass-passivated junction
- Ultrafast reverse recovery time
- Low forward voltage drop
- Low leakage current
- Low switching losses, high efficiency
- · High forward surge capability
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- AEC-Q101 gualified
- · Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

high frequency For use in rectification and freewheeling application in switching mode converters and inverters for consumer, computer and telecommunication.

MECHANICAL DATA

Case: DO-204AC, molded epoxy over glass body Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/NHE3 - RoHS-compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

| MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted) | | | | | | | | |
|--|---|------------------------|--------|--------|--------|--------|--------|------|
| PARAMETER | SYMBOL | EGP20A | EGP20B | EGP20C | EGP20D | EGP20F | EGP20G | UNIT |
| Maximum repetitive peak reverse voltage | V _{RRM} | 50 | 100 | 150 | 200 | 300 | 400 | V |
| Maximum RMS voltage | V _{RMS} | 35 | 70 | 105 | 140 | 210 | 280 | V |
| Maximum DC blocking voltage | V _{DC} | 50 | 100 | 150 | 200 | 300 | 400 | V |
| Maximum average forward rectified current 0.375" (9.5 mm) lead length at $T_A = 55 ^\circ\text{C}$ | I _{F(AV)} | I _{F(AV)} 2.0 | | | | | | А |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I _{FSM} | I _{FSM} 75 | | | | | А | |
| Operating and storage temperature range | T _J , T _{STG} - 65 to + 150 | | | | | | °C | |

RoHS COMPLIANT EGP20A, EGP20B, EGP20C, EGP20D, EGP20F, EGP20G

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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | | | | | |
|--|---|-----------------------------------|-----------------|-------------|--------|--------|--------|--------|--------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | EGP20A | EGP20B | EGP20C | EGP20D | EGP20F | EGP20G | UNIT |
| Maximum instantaneous forward voltage | 2.0 A | | V _F | = 0.95 1.25 | | | | 25 | V | |
| Maximum DC reverse | | T _A = 25 °C | 1_ | 5.0 | | | | | | |
| blocking voltage | | T _A = 125 °C | I _R | 1R 100 | | | | | μA | |
| Maximum reverse recovery time | I _F = 0.5 I _{rr} = 0.2 | A, I _R = 1.0 A, 5 A | t _{rr} | 50 | | | | ns | | |
| Typical junction capacitance | 4.0 V, 1 | MHz | CJ | 70 45 | | | -5 | pF | | |

| THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted) | | | | | | | | |
|--|---------------------------------|----|--|--|------|--|--|------|
| PARAMETER SYMBOL EGP20A EGP20B EGP20C EGP20D EGP20F EGP20G | | | | | UNIT | | | |
| Turpical thermal registerion | R _{0JA} ⁽¹⁾ | 40 | | | | | | °C/W |
| Typical thermal resistance | R _{0JL} ⁽¹⁾ | 15 | | | | | | 0/10 |

Note

⁽¹⁾ Thermal resistance from junction to ambient, and from junction to lead at 0.375" (9.5 mm) lead length, PCB mounted

| ORDERING INFORMATION (Example) | | | | | | | | | |
|--------------------------------|-----------------|------------------------|---------------|----------------------------------|--|--|--|--|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | | | | | |
| EGP20D-E3/54 | 0.452 | 54 | 4000 | 13" Diameter paper tape and reel | | | | | |
| EGP20D-E3/73 | 0.452 | 73 | 2000 | Ammo pack packaging | | | | | |
| EGP20DHE3/54 (1) | 0.452 | 54 | 4000 | 13" Diameter paper tape and reel | | | | | |
| EGP20DHE3/73 ⁽¹⁾ | 0.452 | 73 | 2000 | Ammo pack packaging | | | | | |

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

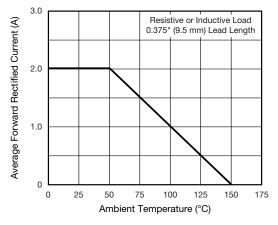


Fig. 1 - Maximum Forward Current Derating Curve

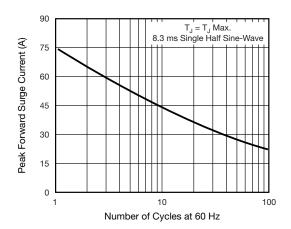


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

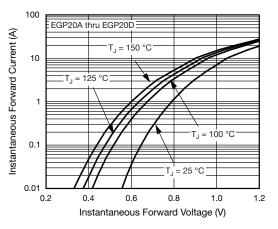
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Fig. 3 - Typical Instantaneous Forward Characteristics

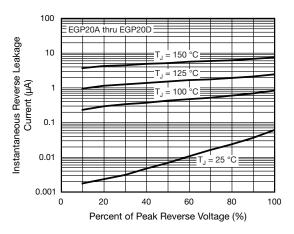


Fig. 4 - Typical Reverse Leakage Characteristics

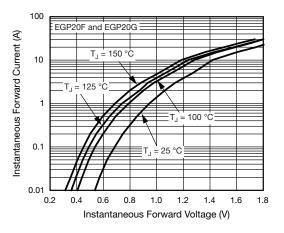


Fig. 5 - Typical Instantaneous Forward Characteristics

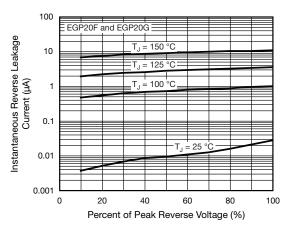


Fig. 6 - Typical Reverse Leakage Characteristics

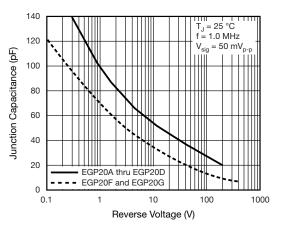


Fig. 7 - Typical Junction Capacitance

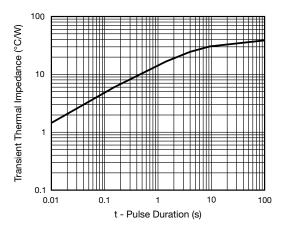


Fig. 8 - Typical Transient Thermal Impedance

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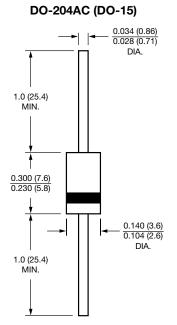
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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